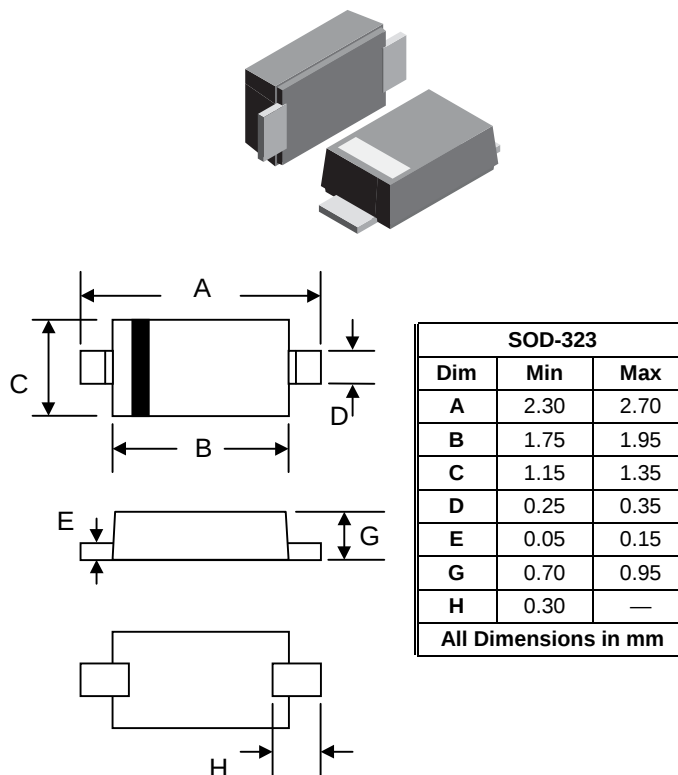


Features

- Low Forward Voltage Drop
- Guard Ring Construction for Transient Protection
- Fast Switching Speed
- Low Capacitance
- Surface Mount Package Ideally Suited for Automatic Insertion

Mechanical Data

- Case: SOD-323, Molded Plastic
- Terminals: Plated Leads Solderable per MIL-STD-202, Method 208
- Polarity: Cathode Band
- Weight: 0.004 grams (approx.)
- Marking: A3



Maximum Ratings $T_A = 25^\circ\text{C}$ unless otherwise specified

Parameter	Symbol	Value	Unit
Repetitive Peak Reverse Voltage	V_{RRM}	70	V
Power Dissipation (Infinite Heatsink)	P_D	400 ⁽¹⁾	mW
Maximum Single Cycle Surge 10 μs Square Wave	I_{FSM}	2	A
Thermal Resistance Junction to Ambient Air	$R_{\theta JA}$	0.3 ⁽¹⁾	$^\circ\text{C}/\text{mW}$
Junction Temperature	T_J	125 ⁽¹⁾	$^\circ\text{C}$
Storage temperature range	T_S	-55 to + 150 ⁽¹⁾	$^\circ\text{C}$

Electrical Characteristics ($T_J = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Reverse Breakdown Voltage	$V_{(BR)R}$	$I_R = 10 \mu\text{A}$	70	-	-	V
Reverse Current	I_R	$V_R = 50 \text{ V}$	-	-	200	nA
Forward Voltage Drop	V_F	$I_F = 1\text{mA}$ $I_F = 15\text{mA}$	-	-	0.41 1.0	V
Diode Capacitance	C_d	$V_R = 0 \text{ V}, f = 1\text{MHz}$	-	-	2.0	pF
Reverse Recovery Time	T_{rr}	$I_F = I_R = 5\text{mA}$, recover to $0.1I_R$	-	-	1	ns

Note:

(1) Valid provided that leads at a distance of 4mm from case are kept at ambient temperature..

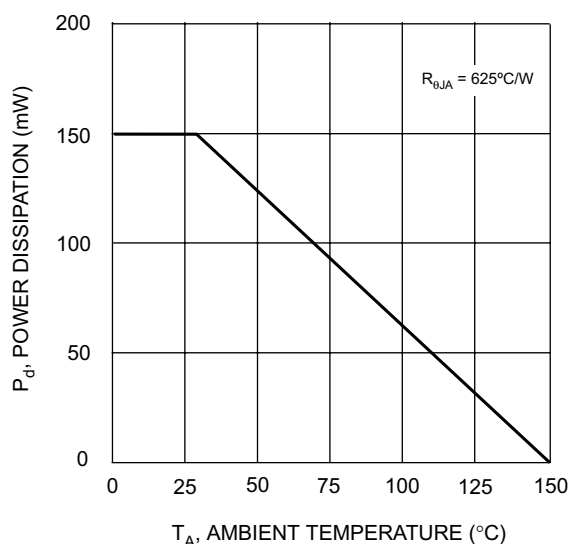


Fig. 1 Derating Curve

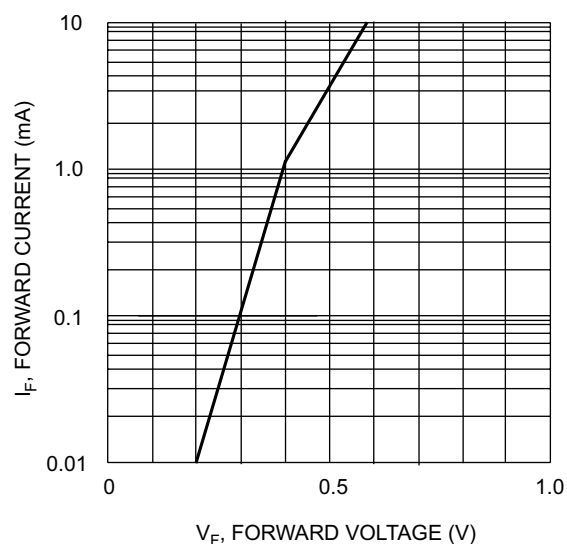


Fig. 2 Typical Forward Characteristics

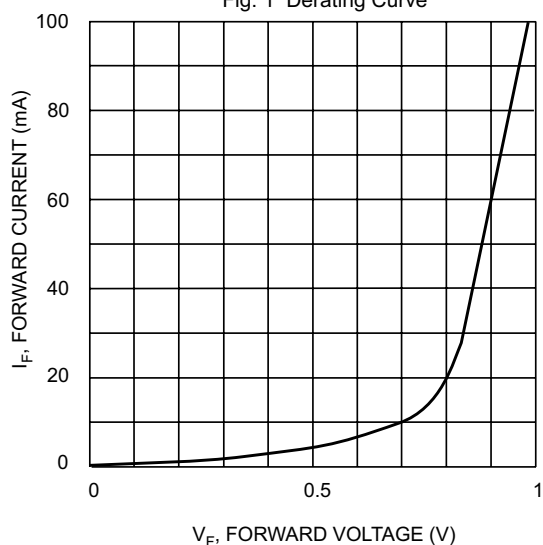


Fig. 3 Typical Forward Characteristics

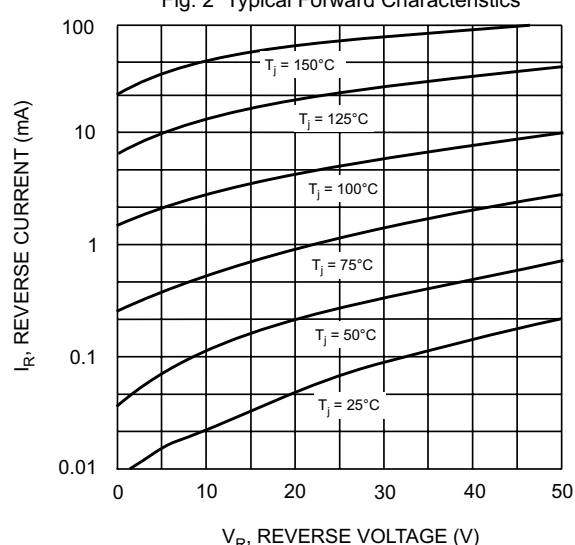


Fig. 4 Typical Reverse Characteristics

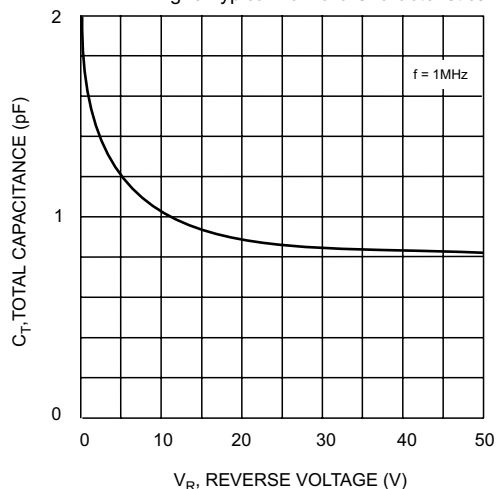


Fig. 5 Total Capacitance vs Reverse Voltage